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Texas Instruments Incorporated
Facsimile: 972-917-4418
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of
Amador et al.

Docket Number: TI-30592.1

Serial No.: 10/731,907

Art Unit: 2822

Filed: 12/08/2003

Examiner: R. Potter

For: **FIXTURE AND METHOD FOR UNIFORM ELECTROLESS METAL
DEPOSITION ON INTEGRATED CIRCUIT BOND PADS**

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NAME OF INVENTOR(S): AMADOR ET AL.		RECEIPT DATE & SERIAL NO.: Serial No.: 10/731,907	
TITLE OF INVENTION: FIXTURE AND METHOD FOR ...		Conf. No: 5802	
TI FILE NO.: TI-30592.1	DEPOSIT ACCT. NO.: 20-0668		
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Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265